ZZI ■Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per Table 1

ZZ2 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

- Z24 These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

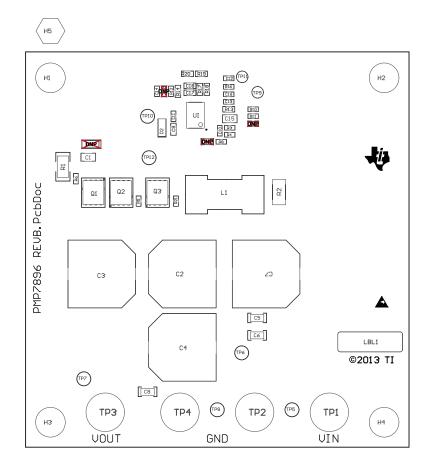


	TABLE 1				
Variant	Label text				
001	ChangeMe!				
002	ChangeMe!				

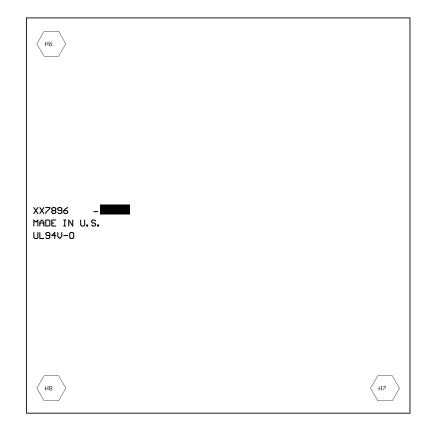
## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS ASSEMBLY VARIANT: 001 $\,$

PCB VIEWED FROM TOP SIDE	BOARD #: XX7896	REV: E1	SVN REV:	Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 3/6/20	013 8:33:40	AM	TEXAS INSTRUMENTS

PCB VIEWED FROM BOTTOM SIDE	BOARD #: XX7896	REV: E1	SVN REV	: Not In VersionControl
		IGNORE ->	er l ay	Bottom Ove
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/6/20	013 8:33:41	AM	TEXAS INSTRUMENTS

ASSEMBLY VARIANT: 001

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS



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